

Jan 28-30, 2026 (Wed-Fri) West Hall, Tokyo Big Sight, Japan

nano tech Secretariat Office JTB Communication Design, Inc.

<Materials Zone Focused Exhibition> Thermal Solutions Area

With the ongoing advancement of power semiconductors, LEDs, electric vehicles, and 5G/6G communication equipment, thermal management has emerged as one of the most critical challenges in recent years.

This trend is clearly reflected at nano tech, where "thermal solutions" have rapidly gained significant presence. On our exhibitor search platform, keywords related to "Thermoelectricity, Insulation, heat dissipation, heat conduction" have consistently ranked in the top 3 for two consecutive years.

In response to this demand, this year's nano tech will feature a specialized "Thermal Solutions Area" as a concentrated exhibition within our "Materials Zone," where state-of-the-art materials and technologies gather.

Efficient Heat Transfer

- High Thermal Conductivity Resins
- Thermally Conductive Fillers (AlN, BN, Graphene, Carbon, etc.)
- Heat Dissipation Ceramics & Sheets
- Thermal Conductive Sheets
- Graphite Sheets
- Metal Nano Pastes
- Nano Carbon Pastes (CNT, Carbon)
- TIM (Thermal Interface Materials)

Target Exhibitors

Thermal Barrier

Thermal Insulation Materials /
Heat Shielding Coatings /
Insulating & High HeatResistant Materials

Energy Utilization

Phase Change Materials (PCM) / Thermoelectric Materials / Cooling Nanofluids

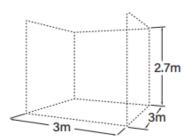
Design thermal integration

Thermal Design Simulation,
Thermal Conductivity
Thermal Resistance
Thermal Diffusivity
Evaluation



Exhibition Fees

Raw Space Only (booth not included)



- *The below exhibition fee including as follows;
- -Exhibitor information page on the official website
- -Viewer information for files or videos on the exhibitor information page.

For more details, please see the Terms and Condition.

*Side panels are provided when the space borders on neighboring booths.

Corner booth spaces include only one side wall.

*The below exhibition fee does NOT cover costs for booths' installation, dismantling, decoration, cleaning, or waste disposal, nor charges for electricity/water supply and drainage or internet fees.

Standard

¥418,000/9m²

University Labs

¥209,000/9m²

*Package booth options are also available separately.

Tax included

Exhibitior Presentation Fees

Seeds & Needs Seminar

Capacity: 100 seats

Fee: 1 session = 45 minutes Fee: 1 session = 30 minutes

¥165,000

¥110,000

- Fees include: Screen and projector for computer-based presentations
 - Audio equipment (2 microphones, speaker)

How to apply



Application Fee		
Exhibition Fees (Standard)	¥418,000 x	spaces = ¥0
Exhibition Fees (Public Organizations) *Only in Japan	¥319,000 x	spaces = ¥0
Exhibition Fees (University Labs)	¥209,000 x	spaces = ¥0
Seeds & Needs Seminar (1 slot: 30 mins.)	¥110,000 x	= ¥0
Seeds & Needs Seminar (1 slot: 45mins.)	¥165,000 x	= ¥0
Remarks or comments Reques	t for Thermal Solutions Area	

- ①Please access the online "Exhibitor Application Form". https://application2.jcdbizmatch.jp/en/nanotech2026/nanotech
- ②Please select "Material Zone" in the "Exhibit Zone" section and fill in the required information.
- ③Please enter the quantity you are applying for items such as "Exhibition Fees" and "Seeds & Needs Seminar"

in the "Application Fee" section.

- Please write "Request for Thermal Solutions Area" in the "Remarks or comments" section below.
- Regarding the booth location, you will select it based on the number of booths and in the order of applications received.



www.nanotechexpo.jp/main/



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